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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Xavier BULLIARD	03/09/2009
Kwang Hee LEE	03/09/2009
Jong Jin PARK	03/09/2009
Yun Hyuk CHOI	03/09/2009
In Sik IN	03/09/2009

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.	
Street Address:	416, Maetan-dong, Yeongtong-gu	
City:	Suwon-si, Gyeonggi-do	
State/Country:	REPUBLIC OF KOREA	
Postal Code:	442-742	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12403871

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NAME OF SUBMITTER: David E. Rodrigues

PATENT

REEL: 022393 FRAME: 0375

Total Attachments: 2 source=29I2115#page1.tif source=29I2115#page2.tif

> PATENT REEL: 022393 FRAME: 0376

ASSIGNMENT

WHEREAS We, Xavier BULLIARD of Samsung Advanced Institute of Technology, Nongseo-dong, Giheung-gu, Yongin-si, Gyeonggi -do 446-712, Republic of Korea; Kwang Hee LEE of 115-1802, Byoksan Apt., Mangpo-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do 443-707 Republic of Korea; Jong Jin PARK of 107-1401, Sinil Utovill Apt., Sangha-dong, Giheung-gu, Yongin-si, Gyeonggi-do 446-568, Republic of Korea; Yun Hyuk CHOI of 104-1203, Samsung Apt., Sindang 4-dong, Jung-gu, Seoul 100-450, Republic of Korea; and In Sik IN of 123, Geomdan-ri, Iryu-myeon, Chungju-si, Chungcheongbuk-do 380-871, Republic of Korea, (hereinafter referred to as "ASSIGNORS"); have invented certain new

MULTILAYER FILM, METHOD FOR MANUFACTURE THEREOF AND ARTICLES INCLUDING THE SAME

and useful improvements in:

which claims priority to **Korean** Application No. 10-2008-0107022, filed on October 30, 2008, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, Samsung Electronics Co., Ltd. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Republic of Korea having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do 442-742 Republic of Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said

PATENT REEL: 022393 FRAME: 0377 Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: March 9, 2009	X mllown	L.S.
Date: March 9, 2009	Xavier BULLIARD	L.S.
Date: March 9, 2009	Kwang Hee LEE	L.S.
Date: March 9, 2009	Jong Jin PARK	
Date: March 9, 2009	Yun Hyuk CHOI	L.S.
	In Sik IN	L.S.

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RECORDED: 03/13/2009